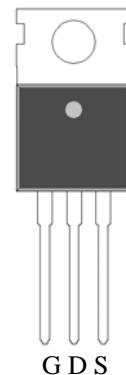


N-Channel Enhancement Mode Power MOSFET

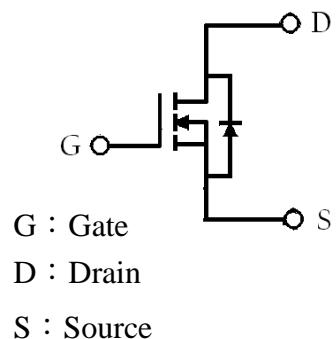
Features:

- Low Gate Charge
- Simple Drive Requirement
- Repetitive Avalanche Rated
- Fast Switching Characteristic
- Pb-free lead plating and RoHS compliant package

TO-220



BV _{DSS}	150V
I _D @V _{GS} =10V, T _C =25°C	36A
I _D @V _{GS} =10V, T _A =25°C	4.6A
R _{D(S)} (ON)@V _{GS} =10V, I _D =30A	33.3mΩ (typ)



G : Gate

D : Drain

S : Source

Ordering Information

Device	Package	Shipping
KWE030N15R	TO-220 (Pb-free lead plating package)	50 pcs/tube, 20 tubes/box, 4 boxes / carton

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 30	
Continuous Drain Current @ $V_{GS}=10\text{V}$, $T_c=25^\circ\text{C}$	I_D	36	A
Continuous Drain Current @ $V_{GS}=10\text{V}$, $T_c=100^\circ\text{C}$		25.5	
Pulsed Drain Current (Note 1)	I_{DM}	144	
Continuous Drain Current @ $V_{GS}=10\text{V}$, $T_A=25^\circ\text{C}$	I_{DSM}	4.6	
Continuous Drain Current @ $V_{GS}=10\text{V}$, $T_A=70^\circ\text{C}$		3.7	
Avalanche Current @ $L=0.1\text{mH}$	I_{AS}	36	
Avalanche Energy @ $L=5\text{mH}$, $I_D=15\text{A}$, $V_{DD}=50\text{V}$ (Note 2)	E_{AS}	560	mJ
Repetitive Avalanche Energy @ $L=0.05\text{mH}$	E_{AR}	13	
Total Power Dissipation ($T_c=25^\circ\text{C}$)	P_D	136	W
Total Power Dissipation ($T_c=100^\circ\text{C}$)		68	
Total Power Dissipation ($T_A=25^\circ\text{C}$)		2.4	
Total Power Dissipation ($T_A=100^\circ\text{C}$)		1.2	
Operating Junction and Storage Temperature	T_j , T_{stg}	-55~+175	°C

Note : 1. Pulse width limited by maximum junction temperature
 2. 100% tested by conditions of $L=0.1\text{mH}$, $I_{AS}=20\text{A}$, $V_{GS}=10\text{V}$, $V_{DD}=50\text{V}$

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-case, max	$R_{\theta JC}$	1.1	
Thermal Resistance, Junction-to-ambient, max	$R_{\theta JA}$	62.5	°C/W

Characteristics ($T_c=25^\circ\text{C}$, unless otherwise specified)

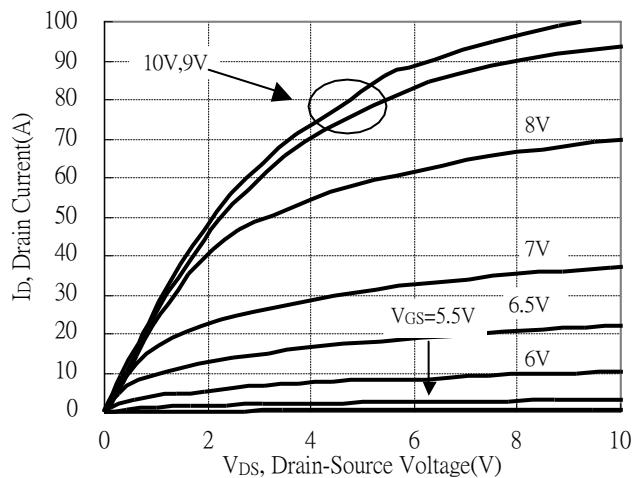
Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV_{DSS}	150	-	-	V	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$
$\Delta BV_{DSS}/\Delta T_j$	-	0.1	-	V/°C	Reference to 25°C , $I_D=250\mu\text{A}$
$V_{GS(th)}$	2.0	-	4.0	V	$V_{DS} = V_{GS}$, $I_D=250\mu\text{A}$
G_{FS}	-	16	-	S	$V_{DS}=10\text{V}$, $I_D=20\text{A}$
I_{GSS}	-	-	± 100	nA	$V_{GS}=\pm 30\text{V}$
I_{DS}	-	-	1	μA	$V_{DS}=120\text{V}$, $V_{GS}=0\text{V}$
	-	-	25		$V_{DS}=100\text{V}$, $V_{GS}=0\text{V}$, $T_j=125^\circ\text{C}$
$*R_{DS(ON)}$	-	33.3	42	mΩ	$V_{GS}=10\text{V}$, $I_D=30\text{A}$
Dynamic					
$*Q_g$	-	34.8	52	nC	$I_D=20\text{A}$, $V_{DS}=75\text{V}$, $V_{GS}=10\text{V}$
$*Q_{gs}$	-	11.3	-		
$*Q_{gd}$	-	9.6	-		

*t _{d(ON)}	-	21.2	-	ns	V _{DS} =75V, I _D =20A, V _{GS} =10V, R _G =3Ω
*t _r	-	20.6	-		
*t _{d(OFF)}	-	34.6	-		
*t _f	-	9	-		
C _{iss}	-	1773	-	pF	V _{GS} =0V, V _{DS} =75V, f=1MHz
C _{oss}	-	104	-		
C _{rss}	-	12	-		
R _g	-	2.2	-		
Source-Drain Diode					
*I _s	-	-	43	A	
*I _{SM}	-	-	172		
*V _{SD}	-	0.9	1.2	V	I _s =30A, V _{GS} =0V
*t _{rr}	-	57	-	ns	I _F =20A, V _{GS} =0V, dI _F /dt=100A/μs
*Q _{rr}	-	143	-	nC	

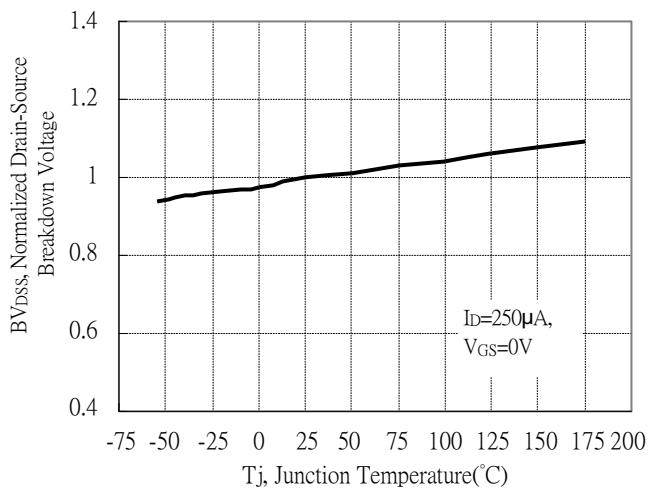
*Pulse Test : Pulse Width ≤300μs, Duty Cycle≤2%

Typical Characteristics

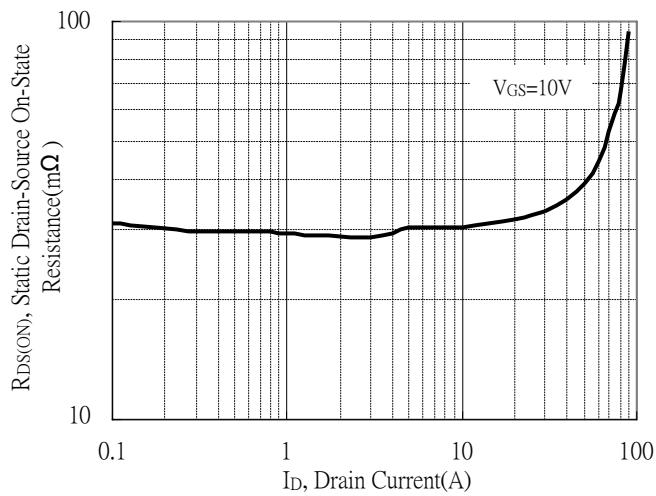
Typical Output Characteristics



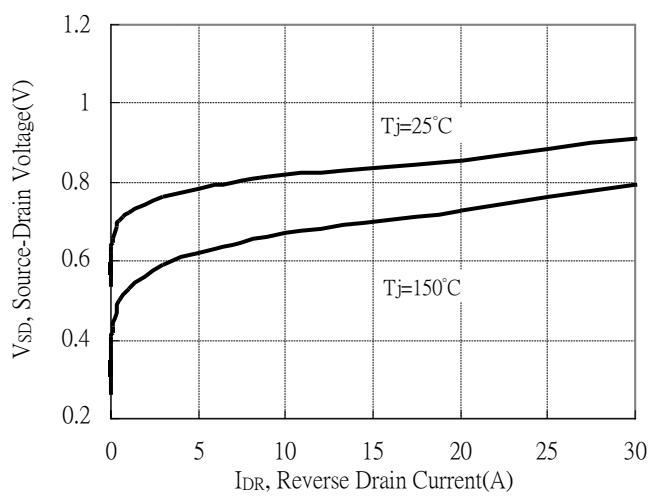
Breakdown Voltage vs Junction Temperature



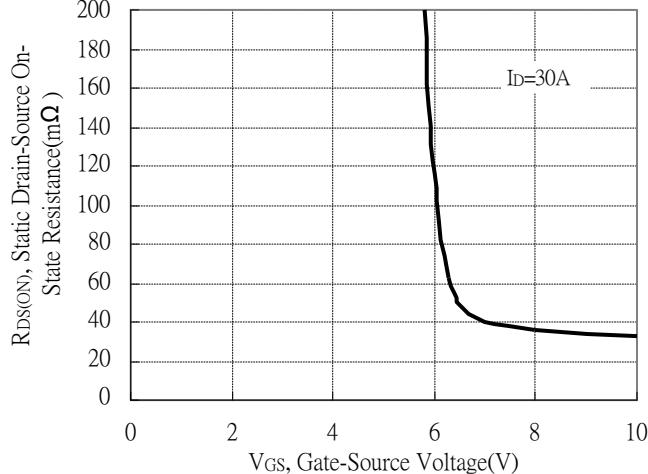
Static Drain-Source On-State resistance vs Drain Current



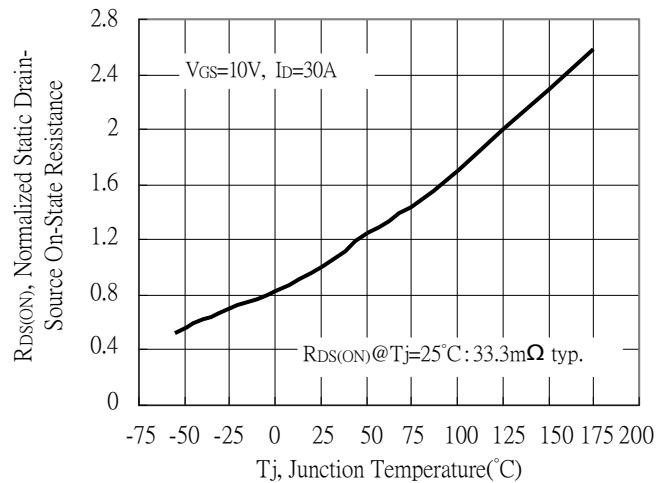
Reverse Drain Current vs Source-Drain Voltage



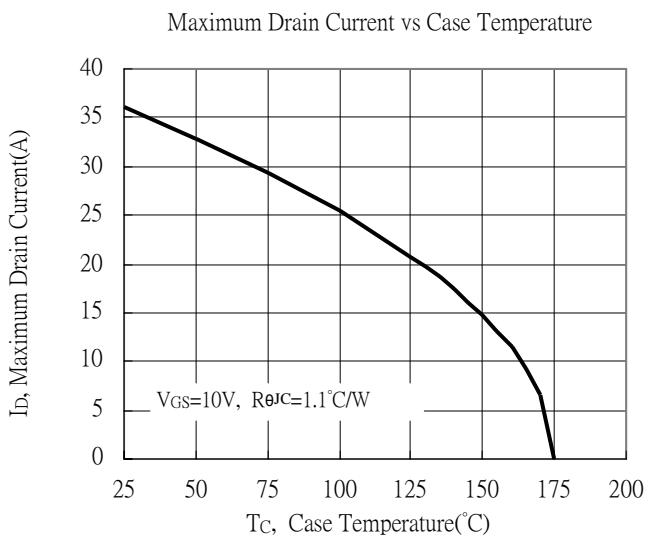
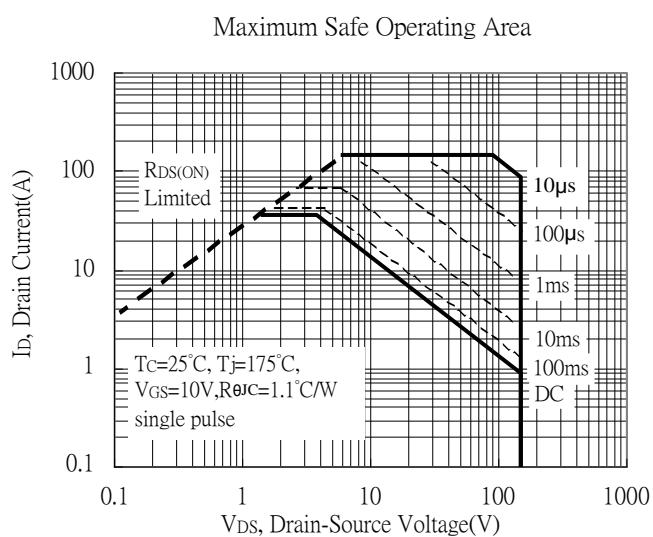
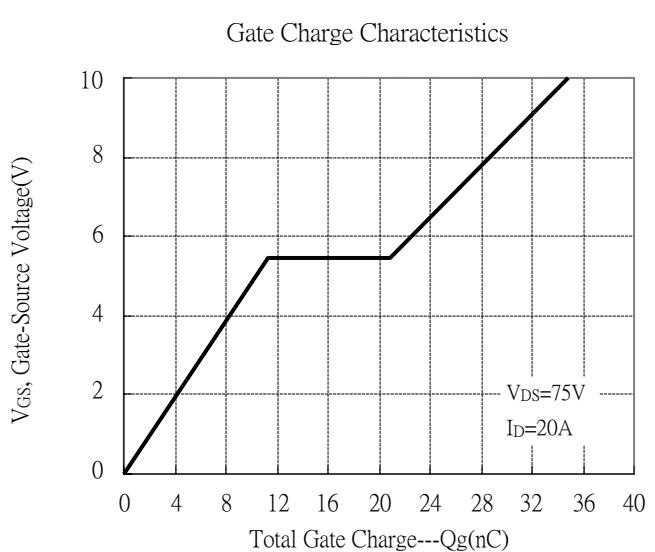
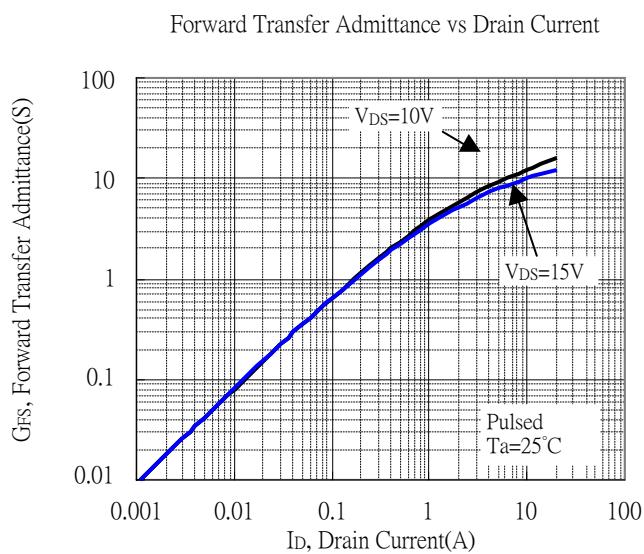
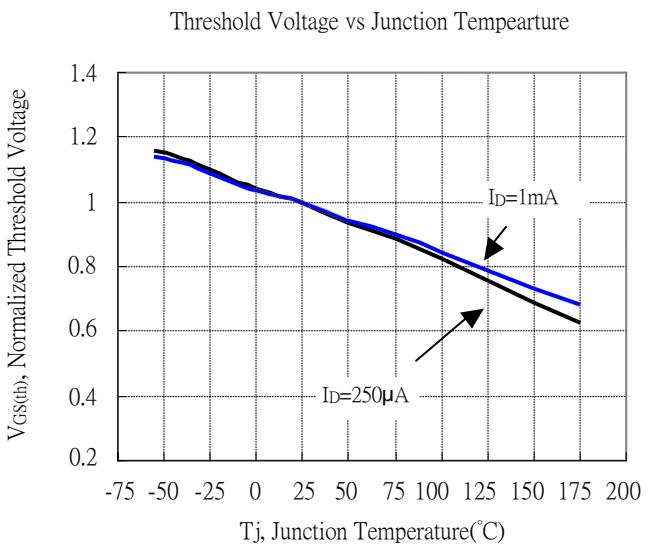
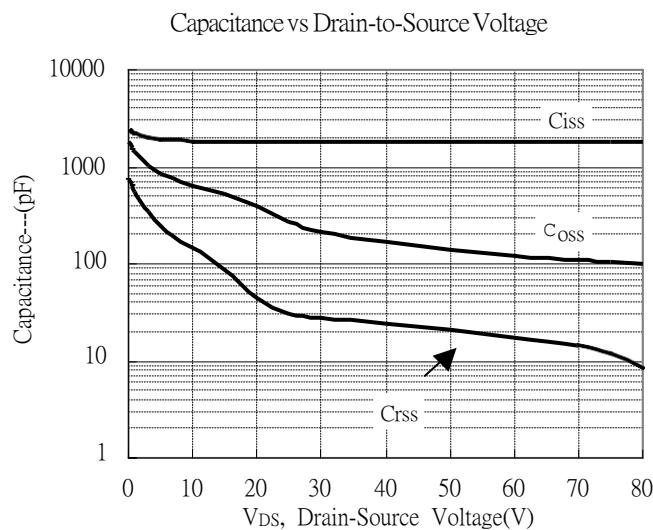
Static Drain-Source On-State Resistance vs Gate-Source Voltage



Drain-Source On-State Resistance vs Junction Temperature

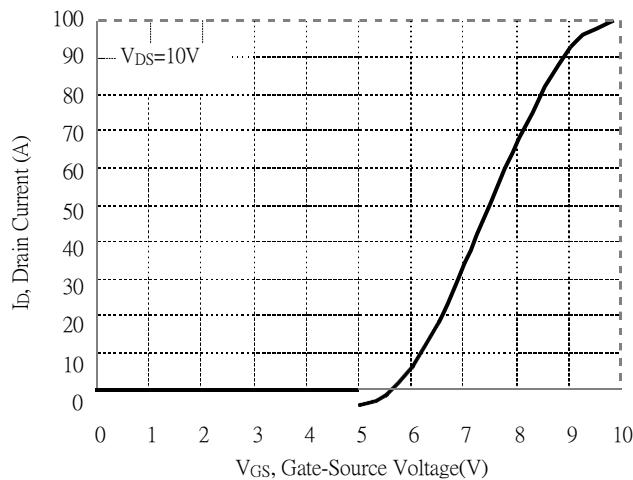


Typical Characteristics(Cont.)

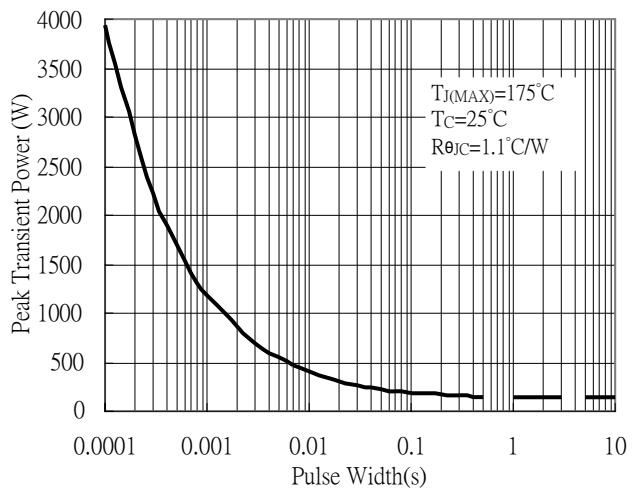


Typical Characteristics(Cont.)

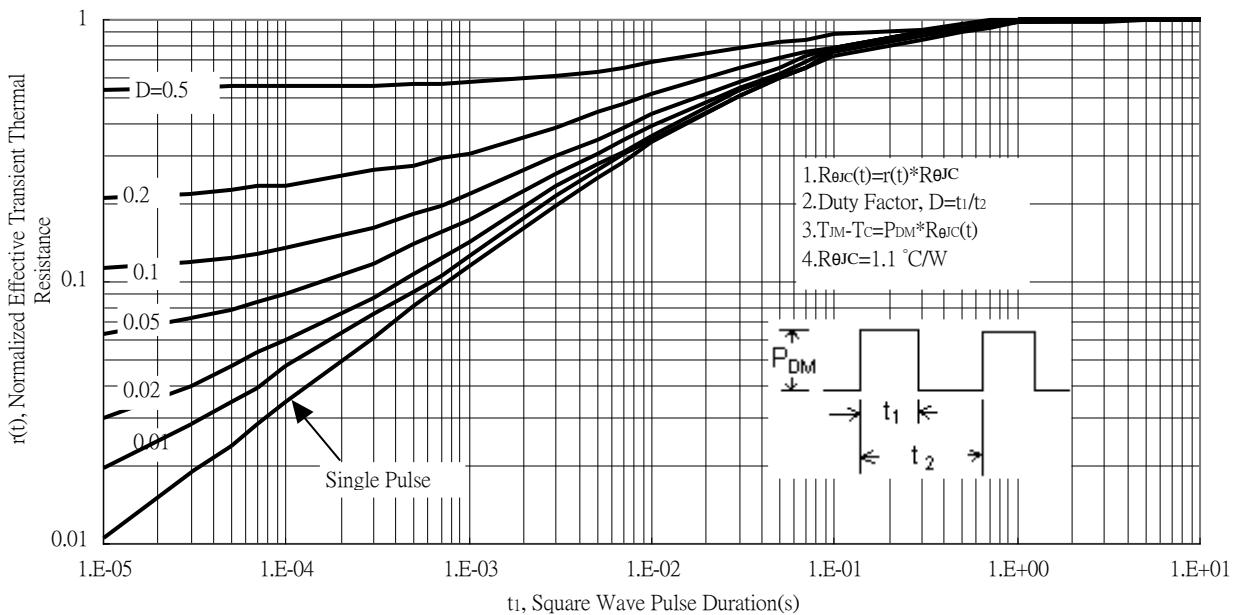
Typical Transfer Characteristics



Single Pulse Maximum Power Dissipation

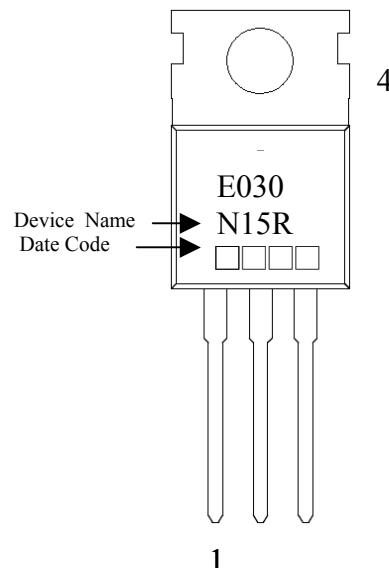
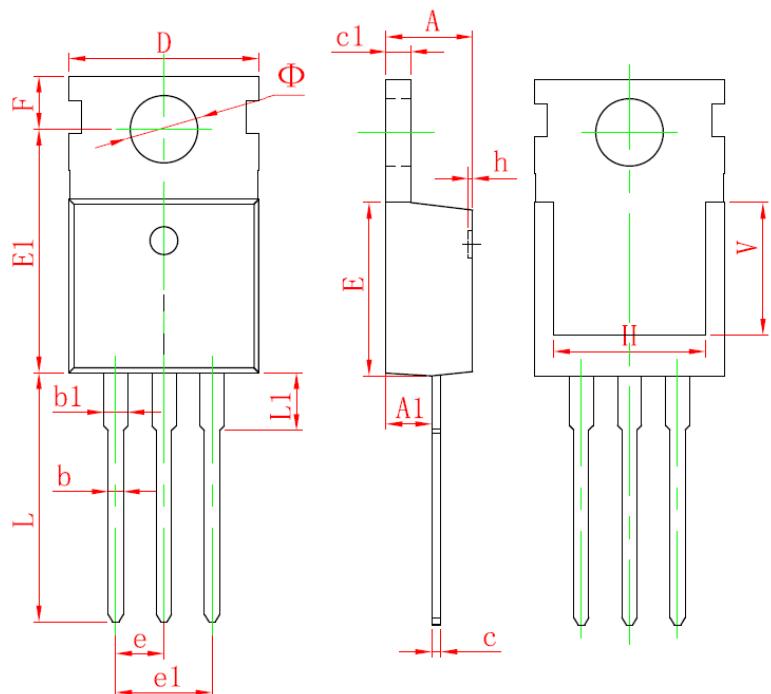


Transient Thermal Response Curves



TO-220 Dimension

Marking:



3-Lead TO-220 Plastic Package
 CYStek Package Code: E3

Style: Pin 1.Gate 2.Drain 3.Source
 4.Drain

*: Typical

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181	e	2.540*		0.100*	
A1	2.250	2.550	0.089	0.100	e1	4.980	5.180	0.196	0.204
b	0.710	0.910	0.028	0.036	F	2.650	2.950	0.104	0.116
b1	1.170	1.370	0.046	0.054	H	7.900	8.100	0.311	0.319
c	0.330	0.650	0.013	0.026	h	0.000	0.300	0.000	0.012
c1	1.200	1.400	0.047	0.055	L	12.900	13.400	0.508	0.528
D	9.910	10.250	0.390	0.404	L1	2.850	3.250	0.112	0.128
E	8.950	9.750	0.352	0.384	V	7.500 REF		0.295 REF	
E1	12.650	12.950	0.498	0.510	Φ	3.400	3.800	0.134	0.150